Silicon P Channel Power MOS FET High Speed Power Switching

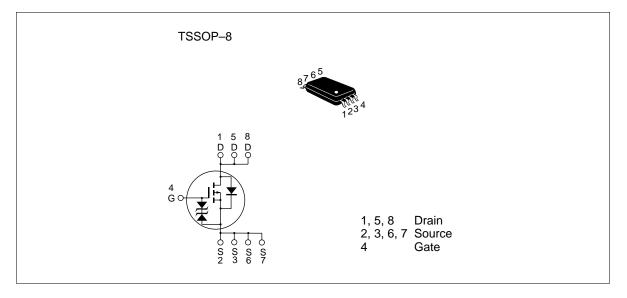
HITACHI

ADE-208-532H (Z) 9th. Edition February 1999

Features

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

Outline





Absolute Maximum Ratings (Ta = 25°C)

| Item | Symbol | Ratings | Unit |
|--|-------------------|---------------|------|
| Drain to source voltage | V _{DSS} | - 20 | V |
| Gate to source voltage | V _{GSS} | ± 10 | V |
| Drain current | I _D | - 3.5 | А |
| Drain peak current | Note1 D(pulse) | - 28 | А |
| Body-drain diode reverse drain current | I _{DR} | - 3.5 | А |
| Channel dissipation | Pch Note2 | 1.3 | W |
| Channel temperature | Tch | 150 | °C |
| Storage temperature | Tstg | – 55 to + 150 | °C |

Note: 1. $PW \le 10\mu s$, duty cycle $\le 1 \%$

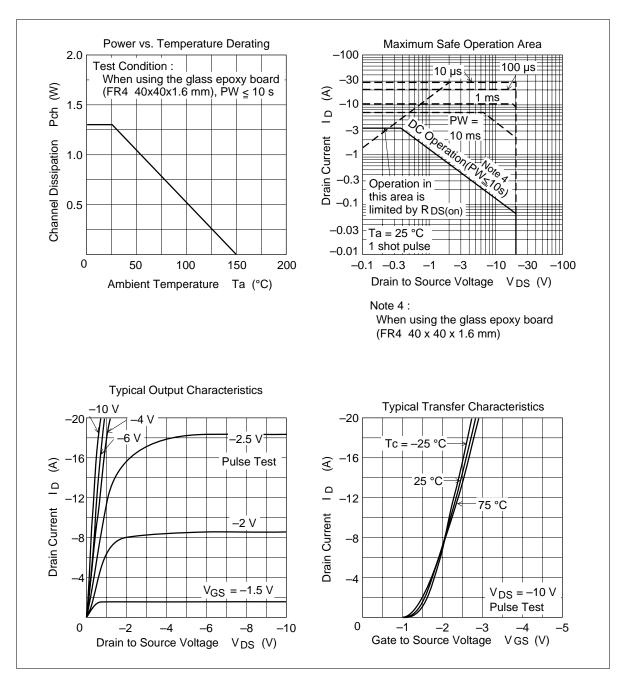
2. When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW \leq 10s

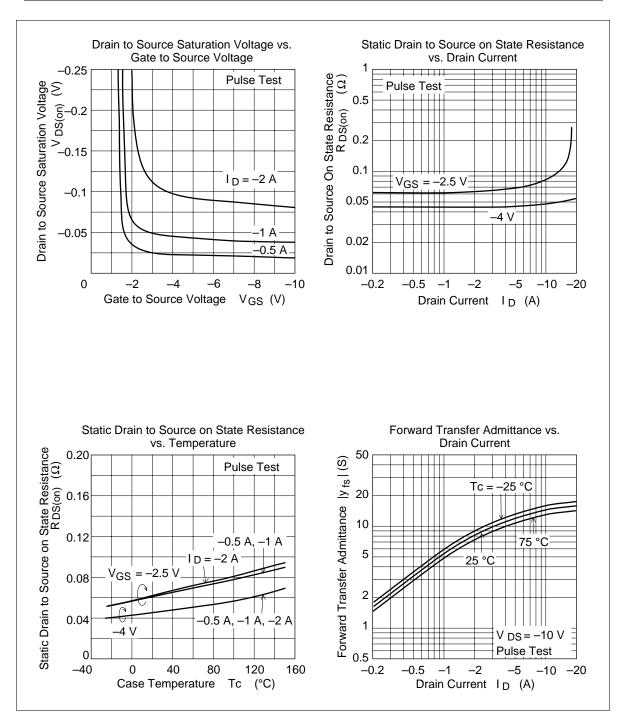
Electrical Characteristics (Ta = 25°C)

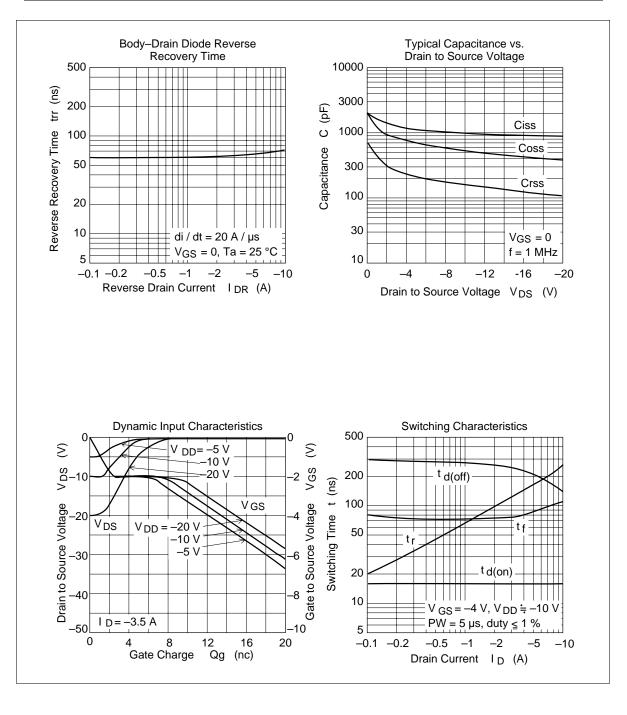
| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|--|----------------------|-------|--------|--------|------|---|
| Drain to source breakdow voltage | $V_{(BR)DSS}$ | - 20 | — | | V | $I_{\rm D} = -10$ mA, $V_{\rm GS} = 0$ |
| Gate to source breakdown voltage | $V_{(BR)GSS}$ | ± 10 | _ | _ | V | $I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$ |
| Gate to source leak current | I _{GSS} | — | — | ± 10 | μA | $V_{\rm GS}=\pm 8~V,~V_{\rm DS}=0$ |
| Zero gate voltege drain current | I _{DSS} | — | — | - 1 | μΑ | $V_{\rm DS} = -20$ V, $V_{\rm GS} = 0$ |
| Gate to source cutoff voltage | $V_{\text{GS(off)}}$ | - 0.4 | — | - 1.4 | V | $V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$ |
| Static drain to source on state | $R_{\text{DS(on)}}$ | | 0.046 | 0.063 | Ω | $I_{\rm D} = -2$ A, $V_{\rm GS} = -4$ V ^{Note3} |
| resistance | $R_{\text{DS(on)}}$ | _ | 0.061 | 0.090 | Ω | $I_{\rm D} = -2$ A, $V_{\rm GS} = -2.5$ V ^{Note3} |
| Forward transfer admittance | y _{fs} | 5 | 8.0 | _ | S | $I_{\rm D} = -2$ A, $V_{\rm DS} = -10$ V ^{Note3} |
| Input capacitance | Ciss | _ | 970 | _ | pF | V _{DS} = - 10 V |
| Output capacitance | Coss | _ | 510 | _ | pF | $V_{GS} = 0$ |
| Reverse transfer capacitance | Crss | | 150 | _ | pF | f = 1MHz |
| Turn-on delay time | t _{d(on)} | | 16 | _ | ns | $V_{GS} = -4 V, I_{D} = -2 A$ |
| Rise time | t, | _ | 100 | _ | ns | $V_{DD} \cong -10 \text{ V}$ |
| Turn-off delay time | $t_{d(off)}$ | | 245 | _ | ns | _ |
| Fall time | t _f | _ | 75 | _ | ns | _ |
| Body-drain diode forward voltage | V_{DF} | _ | - 0.81 | - 1.06 | V | $IF = -3.5 A, V_{GS} = 0^{Note3}$ |
| Body–drain diode reverse recovery time | t _{rr} | | 65 | | ns | $\label{eq:F} \begin{array}{l} {\sf IF} = - \; 3. \; 5{\sf A}, \; {\sf V}_{{\rm GS}} = 0 \\ {\sf diF} / \; {\sf dt} \; = 20 \; {\sf A} / \mu {\sf s} \end{array}$ |

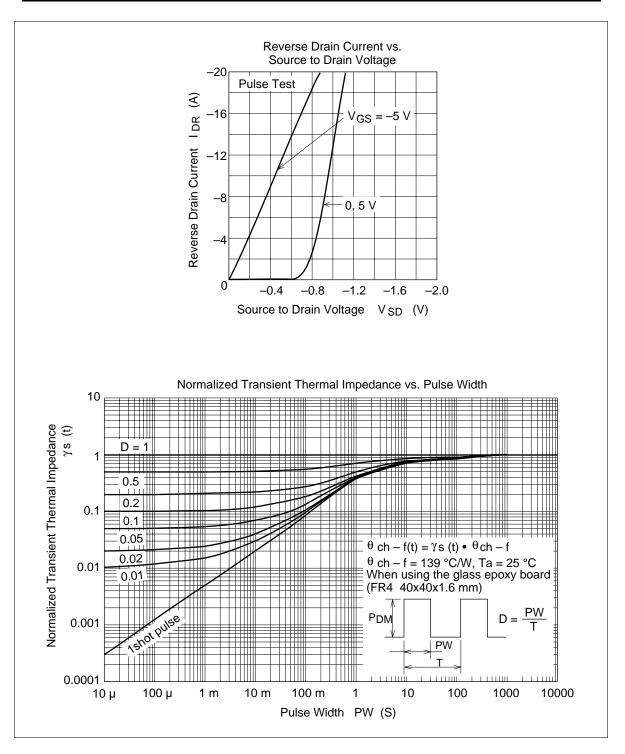
Note: 3. Pulse test

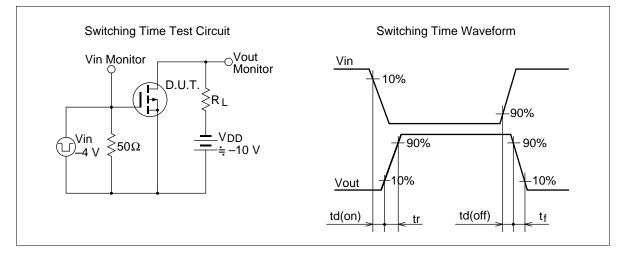
Main Characteristics











Package Dimensions

 3.00 ± 0.1 8 1111 5 4.40 ± 0.1 • 1 1 4 10 Max 6.40 ± 0.20 विषामा ſŧ - 8 ° 0.65 $0.07^{\,+0.03}_{\,-0.04}$ 0.17 ± 0.05 0.50 ± 0.10 □ 0.10 0.22 +0.08 -0.07 ⊕ 0.13 M Hitachi code TTP-8D EIAJ JEDEC

Unit: mm

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